		1				
	0170915000 <mark>A</mark>	PC	CN Date:	Oct. 2	2, 2017	7
Title: Datasheet for TPS549D22						
Customer Contact: PC	N Manager			De	pt:	Quality Services
Change Type:						
Assembly Site		esign			Wafer	Bump Site
Assembly Process	⊠ D	ata Sheet			Wafer	Bump Material
Assembly Materials	Р	art number	change		Wafer	Bump Process
Mechanical Specificati	ion 🔲 T	est Site			Wafer	Fab Site
Packing/Shipping/Lab	eling 🔲 T	est Process			Wafer	Fab Materials
					Wafer	Fab Process
Notification Details						
Description of Change:						
Texas Instruments Incorpo					tificatio	on.
The product datasheet(s) is being updated as summarized below.						
The following change histo	ory provides fui	rther details				
TEXAS TEXAS						
INSTRUMENTS			SLUS	210Δ _ ΔI	IGUST 2016	TPS549D22 6-REVISED SEPTEMBER 2017
THE PROPERTY OF SERVICES AND SERVICES			32030	JIBA - AC	70031 2010	10.02.000
Changes from Original (August	2016) to Revision	A				Page
Changed package name to correct "LQFN-CLIP"						1
add links for WEBENCH						
Added MIN and MAX values for VDD UVLO rising threshold						
Added MIN and MAX for all Soft Start settings and table notes 3 and 4 in Electrical Characteristics						
Changed V _{OUT} = 5 V to V _{OUT} = 5.5 V for Figure 24						
Added note 2 for "Allowable Mode Selection" table						
Added Application Workaround to Support 4-ms and 8-ms SS Settings						
Added Figure 27 and Figure 28						
Added "programmable" between "1-ms" and "delay"						
Changed 0, 1, 4 from "R/W" to "R" in ON_OFF CONFIG figure and table						
Deleted duplicative STATUS_BYTE table and figure						
Changed "286" to "2.86" in Minimum Output Capacitance to Ensure Stability subsection						
• Changed "1.6 μs" to "1.538 μs"; "150 ns" to "300 ns"; and "963 μF" to "969 μF" in <i>Response to a Load Transient</i>						
The detect of a surely and will	l hli					
The datasheet number will be changing.		Changa Fu	Change From:		Change	. To:
Device Family			JIII.		Change To:	
TPS549D22		SLUSCI9			SLUSC	I9A
These changes may be rev	viewed at the d	latasheet lin	ks provided.			
,		ideasireet iii	no provided.			
http://www.ti.com/produc	t/1PS549D22					
Reason for Change:						
To accurately reflect device	e characteristic	~s				
•			ity or Polic	hilit	, (noci	tivo / nogotivo).
Anticipated impact on F						
In order to ensure either						
system, additional application consideration is needed. The recommended application						
workaround to support the 4-ms and 8-ms soft-start settings is to ensure sufficient time delay between the VDD and EN_UVLO signals. There are no changes to the actual device.						
Changes to product identification resulting from this PCN:						
None.						
Product Affected:						
TPS549D22RVFR	TPS549D22R\	/FT				

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com